

# 65C MT9.PT.TSN / 0004 / INF Joint meeting with IEEE 802.1 TSN 2018-03-23

# INTERNATIONAL ELECTROTECHNICAL COMMISSION

TC65: Industrial-process measurement, control and automation

SC65C: Industrial communication networks

Meeting: 65C/MT9/PT 60802 (TSN) Project Team for: IEC/IEEE 60802 Time-

sensitive networking profile for industrial automation and IEEE 802.1

Time-Sensitive Networking (TSN) Task Group

Further called in this document: "IEC/IEEE JWG TSN or JWG TSN"

Minutes: Meeting based on documents listed in Annex B and the meeting

announcement, see IEC collaboration tool

**Date**: 2018-03-06 — 2018-03-08;

Location: Rosemont (Chicago), IL, USA

**Convenor**: Ludwig Winkel

Daily Minutes by: Jordon Woods

Compiled Minutes by: Ludwig Winkel and Jessy Rouyer

**Published**: Collaboration tool http://collaboration.iec.ch/, and IEEE 802.1 web

site http://www.ieee802.org/1/files/public/docs2018/

# 1 General topics

# 1.1 Welcomes and organizational issues: Internet access, lunch, etc. to the IEC/IEEE TSN JWG

Call to order: 06 March 2018, 10:30 AM.

János Farkas, IEEE 802.1 TSN Task Group Chair, and Ludwig Winkel, IEC MT9 Convenor, welcomed the IEC/IEEE TSN JWG organized in

- IEC SC65C/MT9/PT60802 (TSN) Project Team led by Ludwig Winkel; and
- IEEE 802.1 TSN TG, led by János Farkas

The IEC MT9 Convenor explained the intended future organization of the TSN JWG. If the IEEE 802 Executive and New Standards Committees approve this project, the Joint Working Group (JWG) will be established. The IEC/IEEE TSN JWG would be organized in IEEE 802 as a project under the IEEE 802.1 TSN Task Group and in IEC SC65C as a project team of IEC 65C/MT9.

The IEC MT9 Convenor also provided information about the attendance log, lunch and general logistics. Lunch is at the responsibility of participants who have to reserve enough time for lunch to be back in time.

**Disposition**: Administrative

## 1.2 Review minutes, draft agenda and timetable

The draft agenda was reviewed and accepted with modifications. The TSN JWG reviewed the agenda again at the beginning of each meeting day and agreed with the proposed changes. The minutes were reviewed at the end of the meeting.

The final agenda was agreed and used during the meeting, see Annex C.

The IEC MT9 Convenor asked for comments on the minutes of the January 2018 meeting held in Geneva, Switzerland; these minutes were approved without comment.

**Disposition**: Administrative.

NOTE: Access to IEC CollTool is restricted to IEC 65C/MT9 members and their Liaison partners. All cited documents in CollTool are in parallel accessible through the IEEE 802.1 docs2018 public file server.

### 1.3 Membership and attendees; Roster; Administrative

The JWG decided that all participants shall register in the IMAT system. This lowers the handling efforts for the chairs to log the attendance. János Farkas reviewed access to IEEE documents, IMAT, and the TSN TG agenda.

The list below shows the IEC nominated experts and their attendance per day.

NOTE: NC means: Members nominated by an IEC National Committee (NC). JWG means: Affiliation in IMAT if participant registered for JWG.

TSN means: Affiliation in IMAT if participant registered for TSN.

Mar 06, 07 and 08 means: Presence in the JWG meeting if a "1" is in this cell. Note that due to an overlap with other IEEE 802.1 TSN TG sessions in IMAT, some IEEE 802.1 TSN TG participants may or may not have attended the JWG meeting.

The list below shows IEEE 802.1 TSN TG participants having logged their attendance to JWG sessions run independently, or with the rest of the IEEE 802.1 TSN TG.

| Last name  | First<br>Name | Affiliation                   | Tue 6 TSN + JWG<br>(AM2) | Tue 6 JWG (PM) | Wed 7 TSN + JWG<br>(AM1) | Wed 7 JWG (AM2) | Wed 7 JWG (PM2) | Thu 8 JWG (AM + PM1) | Thu 8 TSN + JWG<br>(PM2) |
|------------|---------------|-------------------------------|--------------------------|----------------|--------------------------|-----------------|-----------------|----------------------|--------------------------|
| Adachi     | Yoshiaki      | Hitachi, Ltd.                 | 1                        | 1              | 1                        | 1               | 1               | 1                    | 1                        |
| Bao        | Shenghua      | HUAWEI                        |                          |                | 1                        |                 |                 |                      | 1                        |
| Bechtel    | Gordon        | Bechtech                      | 1                        |                | 1                        |                 |                 |                      | 1                        |
| Belliardi  | Rudy          | Schneider Electric; IEC TC 65 | 1                        | 1              | 1                        | 1               |                 | 1                    | 1                        |
| Bierschenk | Jens          | Robert Bosch GmbH             | 1                        | 1              | 1                        |                 |                 |                      | 1                        |
| Boiger     | Christian     | b-plus GmbH                   | 1                        | 1              | 1                        |                 |                 | 1                    | 1                        |
| Chang      | Xin           | Huawei Technologies Co. Ltd   | 1                        | 1              |                          |                 | 1               | 1                    |                          |
| Chen       | David         | Nokia                         | 1                        |                | 1                        | 1               |                 | 1                    | 1                        |
| Chen       | Feng          | Siemens AG                    | 1                        | 1              | 1                        | 1               |                 |                      | 1                        |
| Chen       | Leo           | Kyland Corporation            |                          |                |                          |                 | 1               | 1                    | 1                        |
| Cheng      | Weiying       | Coriant                       |                          |                |                          | 1               |                 |                      |                          |
|            |               | National Instruments          |                          |                |                          |                 |                 |                      |                          |
| Cummings   | Rodney        | Corporation                   |                          | 1              | 1                        |                 |                 |                      | 1                        |

|           |            |   | Tue 6 TSN + JWG<br>(AM2) | rue 6 JWG (PM) | Wed 7 TSN + JWG<br>(AM1) | Wed 7 JWG (AM2) | Wed 7 JWG (PM2) | Thu 8 JWG (AM +<br>PM1) | Thu 8 TSN + JWG<br>(PM2) |
|-----------|------------|---|--------------------------|----------------|--------------------------|-----------------|-----------------|-------------------------|--------------------------|
|           |            |   | TSN (                    | JWG            | 7 TSN<br>)               | 7 JWG           | 7 JWG           | JWG                     | TSN (                    |
| Last name | First      | Affiliation                                   | Tue 6 7<br>(AM2)         | ne 6           | Ned<br>AM1               | Ned             | /ved            | Thu 8<br>PM1)           | rhu 8<br>PM2             |
| Last name | Name       | Affiliation                                   |                          |                |                          | _               |                 |                         | _                        |
| Dorr      | Josef      | Siemens AG                                    | 1                        | 1              | 1                        | 1               |                 | 1                       |                          |
| Elbakoury | Hesham     | Huawei Technologies Co. Ltd                   | 1                        | 1              | 1                        | 1               |                 | 1                       |                          |
| Ellegaard | Lars       | Microsemi Corporation                         | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Enzinger  | Thomas     | B&R Industrial Automation                     | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Fan       | Viaciina   | Fujitsu Research &                            | 1                        | 1              | 1                        |                 |                 |                         |                          |
|           | Xiaojing   | Development Center  ZTE TX Inc                | 1                        | 1              | 1                        | 1               | 1               |                         |                          |
| Fang      | Yonggang   |   | 1                        |                |                          | 1               | 1               |                         | 1                        |
| Farkas    | Janos      | Ericsson                                      | 1                        |                | 1                        |                 |                 |                         | 1                        |
| Finn      | Norman     | Huawei Technologies Co. Ltd                   |                          |                | 1                        |                 |                 |                         | 1                        |
| Fontaine  | Mickael    | TransPacket                                   | 1                        |                | 1                        |                 |                 | 4                       |                          |
| Garner    | Geoffrey   | Huawei Technologies Co. Ltd                   | 1                        | 4              | 1                        | 1               | 1               | 1                       | 1                        |
| Gravel    | Mark       | Hewlett Packard Enterprise                    | 1                        | 1              | 1                        |                 |                 |                         | 1                        |
| Gunther   | Craig      | HARMAN INTERNATIONAL INDUSTRIES, INCORPORATED | 1                        |                | 1                        |                 |                 |                         | 1                        |
| Gutierrez | Marina     | TTTech Computertechnik AG                     | 1                        |                | 1                        |                 |                 |                         | 1                        |
| Gutterrez | IVIALIIIA  | Stephen Haddock Consulting,                   |                          |                |                          |                 |                 |                         | 1                        |
| Haddock   | Stephen    | LLC   |                          |                | 1                        |                 |                 |                         | 1                        |
| Hantel    | Mark       | Rockwell Automation                           | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Harima    | Taro       | Mitsubishi Electric Corporation               | 1                        |                | 1                        | 1               | 1               | 1                       | 1                        |
|           |            | Advanced                                      |                          |                |                          |                 |                 |                         |                          |
|           |            | Telecommunications Research                   |                          |                |                          |                 |                 |                         |                          |
| Hasegawa  | Akio       | Institute International (ATR)                 | 1                        |                | 1                        | 1               | 1               | 1                       |                          |
| Holness   | Marc       | Ciena Corporation                             | 1                        |                | 1                        |                 |                 |                         |                          |
| Hotta     | Yoshifumi  | Mitsubishi Electric Corporation               | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Hung      | Soar       | Realtek Semiconductor Corp.                   | 1                        | 1              | 1                        |                 |                 |                         | 1                        |
| Kabra     | Lokesh     | Synopsys, Inc.                                |                          |                | 1                        | 1               | 1               | 1                       |                          |
| Karl      | Michael    | Marvell Semiconductor, Inc.                   | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
|           | a          | Hirschmann Automation and                     |                          | _              |                          |                 |                 |                         | _                        |
| Kehrer    | Stephan    | Control, Inc.                                 | 1                        | 1              | 1                        |                 | 1               | 1                       | 1                        |
| KONDO     | Kenji      | Yaskawa Electric Corp                         |                          |                | 1                        | 1               | 1               | 1                       | 1                        |
|           |            | National Institute of<br>Information and      |                          |                |                          |                 |                 |                         |                          |
|           |            | Communications Technology                     |                          |                |                          |                 |                 |                         |                          |
| кото      | Hajime     | (NICT)  | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Lawlis    | James      | Ford Motor Company                            | 1                        |                | 1                        | 1               | 1               | 1                       | 1                        |
| 20.77113  | 34.1163    | Shenyang Insititue of                         | <u> </u>                 |                |                          |                 |                 |                         |                          |
|           |            | Automation, Chinese Academy                   |                          |                |                          |                 |                 |                         |                          |
| Li        | Dong       | of Sciences                                   | 1                        | 1              | 1                        | 1               | 1               | 1                       |                          |
| Lutz      | Peter      | Sercos International                          | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Mangin    | Christophe | Mitsubishi Electric Corporation               | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Mansfield | Scott      | Telefon AB LM Ericsson                        | 1                        |                | 1                        |                 |                 |                         |                          |
| Messenger | John       | ADVA Optical Networking Ltd.                  |                          |                | 1                        |                 | 1               |                         | 1                        |
| Mustala   | Tero       | Nokia Networks                                | 1                        |                | 1                        |                 | 1               |                         | 1                        |

|           | First    |   | Tue 6 TSN + JWG<br>(AM2) | Tue 6 JWG (PM) | Wed 7 TSN + JWG<br>(AM1) | Wed 7 JWG (AM2) | Wed 7 JWG (PM2) | Thu 8 JWG (AM +<br>PM1) | Thu 8 TSN + JWG<br>(PM2) |
|-----------|----------|---|--------------------------|----------------|--------------------------|-----------------|-----------------|-------------------------|--------------------------|
| Last name | Name     | Affiliation   |                          | •              |                          |                 | _               |                         | -                        |
| Nomizu    | Takuma   | Hitachi, Ltd.   | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
|           | F        | National Institute of Information and Communications Technology |                          | 4              |                          | 4               | 4               |                         |                          |
| Ohori     | Fumiko   | (NICT)  | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Ohsawa    | Tomoki   | NICT  | 1                        |                |                          | 1               | 1               | 1                       | 1                        |
| Osagawa   | Daisuke  | Mitsubishi Electric Corporation                                 | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Pannell   | Donald   | NXP Semiconductors  | 1                        | 1              | 1                        | 1               | 1               |                         | 1                        |
| Parsons   | Glenn    | Ericsson AB   |                          | 1              | 1                        |                 |                 |                         | _                        |
| Potts     | Michael  | General Motors Company  | 1                        | 1              | 1                        |                 | 1               | 1                       | 1                        |
| QIU       | WEI .    | Huawei Technologies Co., Ltd                                    | 1                        | 1              | 1                        |                 |                 | 1                       |                          |
| Rouyer    | Jessy    | Nokia   | 1                        |                | 1                        |                 |                 |                         | 1                        |
| Sato      | Atsushi  | Yokogawa Electric Corporation                                   | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Seewald   | Maik     | Cisco Systems, Inc.   | 1                        | 1              | 1                        | 1               |                 | 1                       | 1                        |
| Shen      | Li       | Huawei Technologies Co., Ltd                                    |                          |                |                          |                 |                 | 1                       |                          |
| 6 1.      |          | University of Duisburg-Essen                                    |                          |                |                          |                 |                 |                         |                          |
| Specht    | Johannes | and General Motors Company                                      |                          |                | 1                        | 4               |                 |                         | 1                        |
| Steindl   | Guenter  | Siemens AG  | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Sun       | Liyang   | HUAWEI  | 1                        |                |                          |                 |                 |                         |                          |
| Sun       | Wenhao   | Huawei Technologies Co., Ltd                                    |                          | 1              |                          |                 |                 | 1                       |                          |
| Tarui     | Isao     | Mitsubishi Electric Corporation                                 | 1                        | 1              | 1                        |                 | 1               | 1                       | 1                        |
| Wamsser   | Reiner   | IEC SC65C MT9-Member  | 1                        | 1              | 1                        | 1               | 1               | 1                       |                          |
| wang      | haifei   | Huawei Technologies Co. Ltd                                     |                          |                |                          |                 |                 | 1                       | 1                        |
| Wang      | Нао      | Fujitsu Research & Development Center                           |                          |                |                          | 1               |                 |                         | 1                        |
| Wang      | Xinyuan  | Huawei Technologies Co. Ltd                                     | 1                        | 1              |                          |                 |                 |                         |                          |
| Winkel    | Ludwig   | Siemens AG  | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
|           | _        | British Standards Institution                                   |                          |                |                          |                 |                 |                         |                          |
| Wood      | Graeme   | (BSi), Rockwell Corp  | 1                        | 1              | 1                        | 1               | 1               | 1                       |                          |
| Woods     | Jordon   | Analog Devices, Inc.  | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Yamaura   | Takahiro | Toshiba   | 1                        | 1              | 1                        | 1               | 1               | 1                       | 1                        |
| Yin       | Yue      | Huawei Technologies Co., Ltd                                    |                          | 1              |                          |                 |                 |                         |                          |
| YU        | XIANG    | Huawei Technologies Co., Ltd                                    |                          | 1              |                          |                 |                 | 1                       |                          |
| Zein      | Nader    | NEC Corporation   | 1                        |                | 1                        | 1               |                 |                         | 1                        |
| Zhang     | Jianfeng | kyland  | 1                        |                | 1                        | 1               | 1               | 1                       | 1                        |
| ZHANG     | YUN      | Huawei Technologies Co. Ltd                                     |                          |                |                          |                 |                 | 1                       |                          |

**Disposition**: Administrative.

## 1.4 Copyrights and IPR

At the beginning of the meetings on each day, the IEEE-SA PatCom Patent Slides for Standards Development Meetings and the IEEE 802 Participation slide were presented (<a href="http://standards.ieee.org/about/sasb/patcom/materials.html">http://standards.ieee.org/about/sasb/patcom/materials.html</a>) and the Call for Potentially Essential Patents was made. There were no responses to the calls prior to the end of the week's session.

The IEC MT9 Convenor reminded IEC participants that similar rules apply in IEC. Specifically, the IEC MT9 Convenor reminded all MT9.PT experts that patents required for use of the TSN-IA profile must be announced to IEC and made available using the IEC licensing form. Presentations shall not have copyright marks or confidentiality information.

**Disposition**: Administrative.

### 1.5 Abbreviated terms and acronyms

AVNU Consortium to establish and certify the interoperability of open Audio Video Bridging (AVB)[1] and

Time-Sensitive Networking (TSN) standards.

CD Committee Draft

CDV Committee Draft for Vote

CollTool IEC Collaboration Tool, see <a href="http://collaboration.iec.ch">http://collaboration.iec.ch</a>

CP Communication Profile according to IEC 61784-1 and IEC 61784-2

FDIS Final draft International Standard

IA Industrial automation

IEC International electrotechnical commission

IEC-CO Central office of International Electrotechnical Committee

IEEE Institute of Electrical and Electronics Engineers

IEV International electrotechnical vocabulary

IO Input output

IPR Intellectual Property Rights

ISO International Organization for Standardization

ITU International Telegraph Union

JTC1 Joint Technical Committee 1 of ISO and IEC

JWG Joint WG

MAC Medium access Control
MAU Medium access unit
MM Meeting minutes
MT Maintenance Team

MT9 Maintenance Team 9 of IEC SC65C

NC National Committee

NP New work item proposal

OPC Open platform communications

OPC UA Open platform communications unified architecture

PAR Project authorization request

Phy Physical Layer

PLC Programmable logic controller

PoE Power over Ethernet

preCDV Draft CDV

preFDIS Final Draft International Standard in preparation; "approved for Committee Draft with Vote"-status plus

changes according to RVC and MT9 decision

PT Project team
Q Questionnaire

Rev Revision

RQ Report on questionnaire

RR Review report

RVN Report on voting of an NP

SC Sub-Committee of a TC
SR Stream Reservation
TC Technical Committee

TIA Telecommunications industry association

TSN-IA Time sensitive networking – industrial automation

TSN Time sensitive networking
UNI User Network Interface

WG Working Group

# 1.6 Organizational issues (IEC.ch, CollTool; IEEE IMAT, document repository)

When the JWG between IEC and IEEE is established, all documents will be copied to the IEEE server as well as to the IEC server (CollTool). Until then, the IEEE 802 Chair, IEEE 802.1 TSN TG Chair and the IEC MT9 Convenor will try to make available all shown documents on both servers. For example, the IEC SC65C secretary sends the IEC/IEEE 60802 draft to the IEEE 802.1 Chair as a Liaison document for review.

**Disposition**: Administrative.

### 2 Technical issues

### 2.1 Industrial Use Cases

6 March 2018 AM2 session.

Jordon Woods gave a verbal summary of *Industrial Networking Requirements* <a href="http://www.ieee802.org/3/ad">http://www.ieee802.org/3/ad</a> hoc/ngrates/public/18 03/woods nea 01 0318.pdf as presented to the IEEE 802 New Ethernet Applications Ad Hoc committee on 5 March 2018.

Guenter Steindl presented *Use Cases IEC/IEEE 60802 V0.4*: http://ieee802.org/1/files/public/docs2018/new-industrial-use-cases-0318-v04.pdf.

**Disposition:** Discussion continued in afternoon sessions. It was agreed to copy these uses cases with the modifications done during the meeting in the draft IEC/IEEE 60802 for further review and considerations.

#### 2.2 Industrial Use Cases

6 March 2018 PM1 and PM2 sessions.

Guenter Steindl continued his 6 March 2018 AM2 presentation of use cases.

Josef Dorr agreed to provide a note to consider adding QoS considerations to 2.2 "Minimum Required Quantities".

Thomas Enzinger agreed to provide additional use cases for cycle times, which do not share a common multiple, on the same network. Thomas Enzinger presented on this on 8 March 2018 (see below).

Josef Dorr agreed to work with the contributors on the use case document to add network diagnostics and security use cases to the document. These additional use cases will be presented as a contribution at a future JWG meeting.

Maik Seewald provided a verbal overview of Working Group 10 in IEC TC57:

- Working Group 10 in TC57 IEC 61850 works on a Technical Report: IEC 61850-90-13 "Deterministic Networking".
- The scope is on electrical substations and WAN communication.
- The WG is in an early phase; requirements and use cases are in preparation.
- The objective is to present status (especially use cases) to find out about synergies/matching use cases in the next meeting.

**Disposition:** Related to new project; more discussion needed.

### 2.3 Review of the minutes of the day

6 March 2018 PM2 session.

Jordon Woods reviewed the minutes of the day.

**Disposition**: Administrative.

### 2.4 P60802 PAR & CSD

7 March 2018 AM1 session.

Ludwig Winkel and János Farkas used *P60802 Time-Sensitive Networking Profile for Industrial Automation Resolution of Comments on Project Authorization Request (PAR) and Criteria for Standards. Development (CSD)* <a href="http://www.ieee802.org/1/files/public/docs2018/60802-PAR-CSD-comments-0318-v01.pdf">http://www.ieee802.org/1/files/public/docs2018/60802-PAR-CSD-comments-0318-v01.pdf</a> to support the resolution of comments received on the draft PAR and CSD for proposed P60802 *Time-Sensitive Networking Profile for Industrial Automation*.

**Disposition**: The JWG agreed on the following updated PAR/CSD and asked Glenn Parsons to bring these to the attention of the IEEE 802.1 Working Group for approval during its midweek plenary on Wednesday 07 March 2018.

- Updated PAR: <a href="http://ieee802.org/1/files/public/docs2018/60802-draft-PAR-0318-v01.pdf">http://ieee802.org/1/files/public/docs2018/60802-draft-PAR-0318-v01.pdf</a>
- Updated CSD: http://ieee802.org/1/files/public/docs2018/P60802-draft-CSD-0118-v01.pdf

The IEEE 802.1 WG voted during its midweek plenary on Wednesday 07 March 2018 on a first motion to forward the updated PAR and CSD to NesCom for approval; however, comments were subsequently received that were reviewed by the JWG (see below) with the intent to vote upon the updated PAR/CSD during the IEEE 802.1 closing plenary.

János Farkas reviewed a second motion for holding bi-weekly teleconferences Mondays from 6:00 AM (US-Pacific) to 8:00AM (US-Pacific).

Both the first and second motions can be found in the IEEE 802.1 midweek plenary slide deck: <a href="http://www.ieee802.org/1/files/public/minutes/2018-03-midweek-plenary-slides.pdf">http://www.ieee802.org/1/files/public/minutes/2018-03-midweek-plenary-slides.pdf</a>

**Disposition**: The JWG agreed to the second motion and asked Glenn Parsons to bring this to the attention of the IEEE 802.1 Working Group for approval during its midweek plenary on Wednesday 07 March 2018.

The IEEE 802.1 WG approved the second motion during its midweek plenary on Wednesday 07 March 2018.

## 2.5 TSN-IA Network Model and IEC/IEEE preCD 60802 Profile draft

7 March 2018 AM1 session.

Taro Harima led a discussion on *TSN-IA Network Model:* http://ieee802.org/1/files/public/docs2018/new-harima-TSN-IA-network-model-0318-v02.pdf

**Straw Poll**: Would you favour splitting the 60802 work into two projects, the first covering only bridge requirements and the second covering additional scope such as end stations?

A clear majority did not favour this proposal.

**Straw Poll**: Would you favour splitting the 60802 work into separate drafts, the first covering only bridge requirements and the second covering additional scope such as end stations?

A clear majority did not favour this proposal.

**Disposition**: Disposition: No further action required.

The JWG agreed that uses cases (both those presented during the 6 March 2018 JWG meeting and future use cases agreed upon by the JWG) be included in the profile as

informative text during the drafting process. There was general agreement on this proposal. It will be decided later whether to keep this in the publication, publish it separately or delete the material.

Josef Dorr led a discussion on the current IEC/IEEE preCD 60802 Profile draft *TIME-SENSITIVE NETWORKING PROFILE FOR INDUSTRIAL AUTOMATION*:

http://www.ieee802.org/1/files/private/liaisons/liaison-65c-60802-Ed1-IS-preCD-OE 20180201 rev5p0 Clean.pdf

Comments were received and noted in the document.

The IEC MT9 Convenor stated that the JWG Profile will follow the IEC template and style guide. Ludwig Winkel agreed to provide a link to the IEC style guide and other IEC information on how to draft an IEC International Standard.

IEC organization:

http://www.iec.ch/

Home of the IEC organization of JWG TSN: IEC 65C/MT9: http://www.iec.ch/dyn/www/f?p=103:7:0::::FSP\_ORG\_ID,FSP\_LANG\_ID:1376,25

Assistance to experts drafting IEC documents:

http://www.iec.ch/standardsdev/resources/draftingpublications/

Reference material:

http://www.iec.ch/members experts/refdocs/

There was a discussion regarding the use of the terms "end station" and "bridged end station". The group agreed that the IEEE 802.1 terminology of "end station" and "bridge" is adequate to describe use case requirements. It was further agreed that use cases in which an end station or bridge are resource-constrained should be considered.

**Disposition:** Related to new project; more discussion needed.

### 2.6 IEC/IEEE preCD 60802 Profile draft

7 March 2018 PM2 session.

Josef Dorr continued to lead the discussion on the current IEC/IEEE preCD 60802 Profile draft. Comments were received and noted in the document.

**Disposition:** Related to new project; more discussion needed.

### 2.7 IEC/IEEE preCD 60802 Profile draft

8 March 2018 AM1 session.

Josef Dorr continued to lead the discussion on the current IEC/IEEE preCD 60802 Profile draft. Comments were received and noted in the document.

The JWG expressed a desire for contributions on the subject of configuration approaches.

**Disposition:** Related to new project; more discussion needed.

## 2.8 Use Case for IEC/IEEE 60802 Multivendor Motion Control

8 March 2018 AM2 session.

Thomas Enzinger presented *Use Case for IEC/IEEE 60802 Multivendor Motion Control*: <a href="http://www.ieee802.org/1/files/public/docs2018/new-industrial-enzinger-multivendor-motion-control-0318-v01.pdf">http://www.ieee802.org/1/files/public/docs2018/new-industrial-enzinger-multivendor-motion-control-0318-v01.pdf</a>

**Disposition:** Related to new project; more discussion needed.

### 2.9 Additional Use Case discussions

8 March 2018 PM1 session.

Guenter Steindl presented *Use Cases IEC/IEEE 60802 V0.5*: http://ieee802.org/1/files/public/docs2018/new-industrial-use-cases-0318-v04.pdf.

**Disposition:** The presented document was updated based on comments received during discussion: <a href="http://ieee802.org/1/files/public/docs2018/new-industrial-use-cases-0318-v05.pdf">http://ieee802.org/1/files/public/docs2018/new-industrial-use-cases-0318-v05.pdf</a>. Related to new project; more discussion needed. The next version of the IEC/IEEE preCD 60802 V0.5 will be uploaded according to the workplan, see Clause 4.

# 3 PAR Review, gaps for TSN-IA profile, summary of the 3 days, work plan, next meetings

#### 3.1 PAR Review

8 March 2018 PM1 session.

János Farkas used P60802 Time-Sensitive Networking Profile for Industrial Automation Resolution of Comments on Project Authorization Request (PAR) and Criteria for Standards. Development (CSD) <a href="http://www.ieee802.org/1/files/public/docs2018/60802-PAR-CSD-comments-0318-v01.pdf">http://www.ieee802.org/1/files/public/docs2018/60802-PAR-CSD-comments-0318-v01.pdf</a> to support the resolution of further comments received on the draft PAR and CSD for proposed P60802 Time-Sensitive Networking Profile for Industrial Automation.

**Disposition**: The group agreed to the PAR changes made during resolution and asked Glenn Parsons to bring this and the unchanged CSD to the attention of the IEEE 802.1 Working Group for approval during its closing plenary on Friday 09 March 2018.

- Updated PAR: <a href="http://www.ieee802.org/1/files/public/docs2018/60802-PAR-0318-v02.pdf">http://www.ieee802.org/1/files/public/docs2018/60802-PAR-0318-v02.pdf</a>
- CSD: http://www.ieee802.org/1/files/public/docs2018/60802-CSD-0318-v01.pdf

The IEEE 802.1 WG approved the corresponding motion during its closing Plenary on Friday 09, March 2018.

## 3.2 Next meetings

## 3.2.1 Straw polls

Ludwig Winkel led a discussion on next meetings. The next JWG meeting will be held in Pittsburgh, PA, USA, 23-25 May 2018.

There was a straw poll for the following options:

- June 25-29 Frankfurt: y: 10
- July 9-13 San Diego (IEEE 802 Plenary): y: 24
- July 23-27 Frankfurt: y: 9

Second straw poll:

If San Diego, ending Friday:

- 2 Days y: 0
- 3 Days y: 29
- 4 Days y: 0
- 5 Days y: 0

Third Straw Poll:

Who could not attend the IEEE 802 Plenary in San Diego?

· Could not attend: 4

Fourth Straw Poll - Support of 2 meetings:

- July 11-13 San Diego?
  - o Y: 30
  - Cannot come: 5
- July 24-26 Europe, e.g., Frankfurt/London (3-day)
  - o Y: 14
  - o Cannot come: 21

It was suggested that the fall 2018 meeting be held during the IEEE 802.1 interim meeting in Oslo, Norway, September 11-13, 2018. There were no objections.

### 3.2.2 Next dates and locations of the IEC/IEEE JWG TSN meetings

Pittsburgh, PA, 23-25 May 2018; meeting hours 8:00 AM to 6:00 PM.

San Diego, CA, 11-13 July 2018; meeting hours 8:00 AM to 6:00 PM.

Frankfurt, Germany, 24-26 July 2018; meeting hours 8:00 AM to 6:00 PM.

Oslo, Norway, 11-13 September 2018; meeting hours 8:00 AM to 6:00 PM.

NOTE The meetings in Pittsburgh, San Diego and Oslo need a registration through the IEEE 802.1 web site and require meeting fees. The meeting in Frankfurt does not require a meeting fee.

### 3.2.3 Remote meetings

Bi-weekly teleconferences Mondays from 6:00 AM (US-Pacific) to 8:00 AM (US-Pacific) starting 19 March 2018.

### 3.3 Gaps for TSN-IA profile

Ludwig Winkel asked the JWG to identify any gaps in the TSN-IA profile. There were no responses.

### 4 Workplan

Ludwig Winkel led a discussion on workflow and agreed to provide a tracked copy, with visible comments, and a clean, dated copy of the preCD 60802 Profile draft and the use case document on the IEEE server as well to the IEC server (CollTool). A copy of the minutes will also be provided.

The target date for the next preCD 60802 Profile draft incorporating the use cases is 30 April 2018.

**Disposition:** Administrative.

## 5 Review of the meeting minutes

8 March 2018 PM2 session.

Jordon Woods reviewed the draft meeting minutes for the full three-day session.

**Disposition**: Administrative. Ludwig Winkel and Jessy Rouyer will compile the final meeting minutes and upload them to the IEC and IEEE file servers.

### 6 Adjournment

The TSN JWG adjourned at 6:00 PM.

# Annex A

# SC65C/MT9.PT schedule

The updated work plan is in Table A.1.

Table A.1 – Work plan for TSN-IA profile document

|          |            |            | Actions TSN-IA profile IEEE     |
|----------|------------|------------|---------------------------------|
| Calender | Date       | End        | 802.1                           |
| Dec-16   |            |            |                                 |
| Jan-17   |            |            |                                 |
| Feb-17   |            |            |                                 |
| Mar-17   |            |            |                                 |
| Apr-17   |            |            |                                 |
| May-17   |            |            |                                 |
| Jun-17   |            |            |                                 |
| Jul-17   |            |            | Asking for a JWG TSN-IA profile |
| Aug-17   |            |            |                                 |
| Sep-17   |            |            |                                 |
| Oct-17   |            |            |                                 |
| Nov-17   | 09.11.2017 |            | Drafting PAR                    |
| Dec-17   |            |            |                                 |
| Jan-18   |            |            |                                 |
| Jan-18   |            | 26.01.2018 | PAR & CSD                       |
| Feb-18   |            |            |                                 |
| Mar-18   |            | 09.03.2018 |                                 |
| Apr-18   |            |            |                                 |
| May-18   |            |            |                                 |
| May-18   | 23.5.18    | 25.5.18    | Pittsburgh                      |
| May-18   |            |            |                                 |
| Jun-18   |            |            |                                 |
| Jul-18   | 09.07.2018 | 13.07.2018 | Meeting San Diego               |
| Jul-18   | 24.07.18   | 26.07.18   | Meeting Frankfurt               |
| Aug-18   |            |            |                                 |
| Sep-18   | 10.09.2018 | 14.09.2018 | Meeting Oslo                    |
| Oct-18   |            |            |                                 |
| Nov-18   | 12.11.2018 | 16.11.2018 | Meeting Bangkok, JWG            |
| Dec-18   |            |            |                                 |
| Jan-19   |            |            |                                 |

## Annex B

## IEC SC65C/MT9.PT documents

The following IEC SC65C MT9.PT documents are downloadable from the IEC server <a href="https://www.iec.ch">www.iec.ch</a> and reflect the basis and results of MT9.PT (Membership required).

65C/875/NP Industrial communication networks – Profiles – Part 6: Time sensitive

networking profile for industrial use based on IEEE 802.1 and IEEE 802.3

65C/896/RVN Result of voting on 65C/875/NP - PNW 65C-875: Industrial communication

networks - Profiles - Part 6: Time sensitive networking profile for industrial use

based on IEEE 802.1 and IEEE 802.3

65C/910/Q QUESTION about conversion of the approved IEC 61784-6 project (Industrial

communication networks – Profiles – Part 6: Time sensitive networking profile

for industrial use based on IEEE 802.1 and IEEE 802.3) into a joint

development project with IEEE 802.1

65C/917/RQ Results of Questionnaire 65C/910/Q: Conversion of the approved IEC 61784-6

project (Industrial communication networks – Profiles – Part 6: Time sensitive networking profile for industrial use based on IEEE 802.1 and IEEE 802.3) into

a joint development project with IEEE 802.1

01.02.2018 IEC CO changed the project number to IEC/IEEE 60802 substituting IEC

61784-6.

IEEE PAR/CSD P60802 positive voted at:

IEEE 802.1: 09.March2018
IEEE 802EC: 10.March2018

# Annex C

# Final Agenda at the end of the meeting

Green marked areas were joint sessions of IEEE 802.1 TG TSN and the IEC SC65C MT9/IEC/IEEE 60802 JWG TSN. The non-green marked areas were IEC SC65C MT9/IEC/IEEE 60802 JWG TSN sessions with overlap of other IEEE 802.1 TG TSN sessions.

## Meeting Agenda of IEC SC65C MT9/IEEE802.1 TSN = IEC/IEEE 6802 held in Rosemont IL (Chicago) at 2018-03-06 ... -08

Ludwig Winkel (Convenor 65C.MT9 JWG TSN = IEC/IEEE 60802 TSN); János Farkas (TG chair of IEEE 802.1 TSN)

| Rev     | VU.4       |         |       | 1311)  |                           |
|---------|------------|---------|-------|--|---------------------------|
| Tuesday | 06.03.2018 | [h:min] | [min] | Topics   |                           |
|         | 10:30      | - 10:45 | 15    | Welcome and organizational issues: Emergency exits, Internet access, lunch, etc. to the IEC - IEEE 802 JWG TSN TG joint session (whole TSN TG) | Ludwig, János             |
|         | 10:45      | - 11:05 | 20    | Agenda   | Ludwig, János             |
|         | 11:05      | - 11:15 | 10    | Membership and attendees; Roster; Administrivia, membership  | Ludwig, János, All        |
|         | 11:15      | - 11:20 | 5     | Copyrights and IPR   | Ludwig, János             |
|         | 11:20      | - 11:30 | 10    | Organizational issues (IEC.ch, CollTool; IEEE imat, document repository)   | Ludwig, János             |
|         | 11:30      | - 11:40 | 10    | Status of Liaison and Joint WG with IEEE 802   | Ludwig, János             |
|         | 11:40      | - 11:40 | 0     |  |                           |
|         | 11:40      | - 12:30 | 50    | Result of IEC 65C/MT9/ahG "use cases"  | Marius, Günter, or others |
|         | 12:30      | - 13:30 | 60    | Lunch break + IEEE Editor's meeting  |                           |
|         | 13:30      | - 13:30 |       |  |                           |
|         | 13:30      | - 15:30 | 120   | Discuss the Draft CD use cases   | Josef                     |
|         | 15:30      | - 15:30 |       |  |                           |
|         | 15:30      | - 16:00 | 30    | Break  |                           |
|         | 16:00      | - 17:50 | 110   | Discuss the Draft CD use cases   | Josef                     |
|         | 17:50      | - 17:50 |       |  |                           |

| 17:50 - 17:50 |    |                              |              |
|---------------|----|------------------------------|--------------|
| 17:50 - 17:50 |    |                              |              |
| 17:50 - 17:50 |    |                              |              |
| 17:50 - 18:00 | 10 | Review of minutes of the day | Minute maker |
| 18:00         |    | Recess of JWG TSN meeting    |              |

| We | 07.03.2018 | n:min] [mir    | Topics                                      |               |
|----|------------|----------------|---|---------------|
|    |            |                | DCB TG PAR                                  |               |
|    | 08:55 - 09 | 9:00           | Review Agenda; expected results of the day  | Ludwig, János |
|    | 09:00 - 09 | 9:45 4         | P60802 PAR & CSD; Planning GoTo meetings    | Ludwig, János |
| ,  | 09:45 - 10 | <b>0:15</b> 3  | Technical discussion; TSN-IA_netowork_model | Taro          |
|    | 10:15 - 10 | <b>0:45</b> 3  | ) Break                                     |               |
|    | 10:45 - 1  | 1:30 4         | Technical discussion; TSN-IA_netowork_model | Taro          |
|    | 11:30 - 12 | <b>2:30</b> 6  | Technical discussion; drafting IEC 60802    | Josef         |
|    | 12:30 - 13 |                | Lunch                                       |               |
|    | 13:30 - 1  | <b>5:30</b> 12 | D IEEE 802.1 Midweek plenary                | Glenn Parsons |
|    | 15:30 - 10 |                | ) Break                                     |               |
|    | 16:00 - 1  |                | , 0   | Josef         |
|    | 17:40 - 18 |                | Review of meeting minutes                   | Minute maker  |
|    | 18:00 - 18 |                | Recess of JWG TSN                           |               |
|    | 18:00 - 18 |                |   |               |
|    | 18:00 - 18 |                | ) Break                                     |               |
|    | 18:30 - 2  | <b>1:30</b> 18 | Social event                                |               |
|    | 21:30      |                |   |               |

| Th | 08.03.2018                      | [maim] | Topics  |                 |
|----|---------------------------------|--------|---|-----------------|
|    | [h:min]<br><b>08:00 - 08:05</b> | [min]  | Review Agenda; Patent etc.                            | Ludwig          |
| 1  | 08:05 - 09:55                   | 110    | Technical discussion; drafting IEC 60802              | Josef           |
|    | 09:55 - 09:55                   |        |   |                 |
|    | 09:55 - 09:55                   |        |   |                 |
|    | 09:55 - 10:35                   | 40     | Break   |                 |
|    | 10:35 - 11:50                   | 75     | Use case contribution                                 | Thomas Enzinger |
|    | 11:50 - 13:30                   |        |   |                 |
|    | 13:30 - 15:00                   | 90     | Preparing Use case contributions                      | Günter etc.     |
|    | 15:00 - 15:00                   |        |   |                 |
|    | 15:00 - 15:30                   | 30     | Break   |                 |
|    | 15:30 - 15:40                   | 10     | PAR comment resolution                                | Ludwig, János   |
|    | 15:40 - 17:00                   | 80     | Next meetings   | Ludwig, János   |
|    | 17:00 - 17:05                   | 5      | Identify and discuss IEEE 802 gaps for TSN-IA profile | Ludwig, János   |
|    | 17:05 - 17:35                   | 30     | Workplan  | Ludwig          |
|    | 17:35 - 17:40                   | 5      | Summary of the 3 days                                 | Ludwig, János   |
|    | 17:40 - 18:00                   | 20     | Review of meeting minutes                             | Minute maker    |
|    | 18:00                           |        | Adjournment of JWG TSN meeting                        |                 |